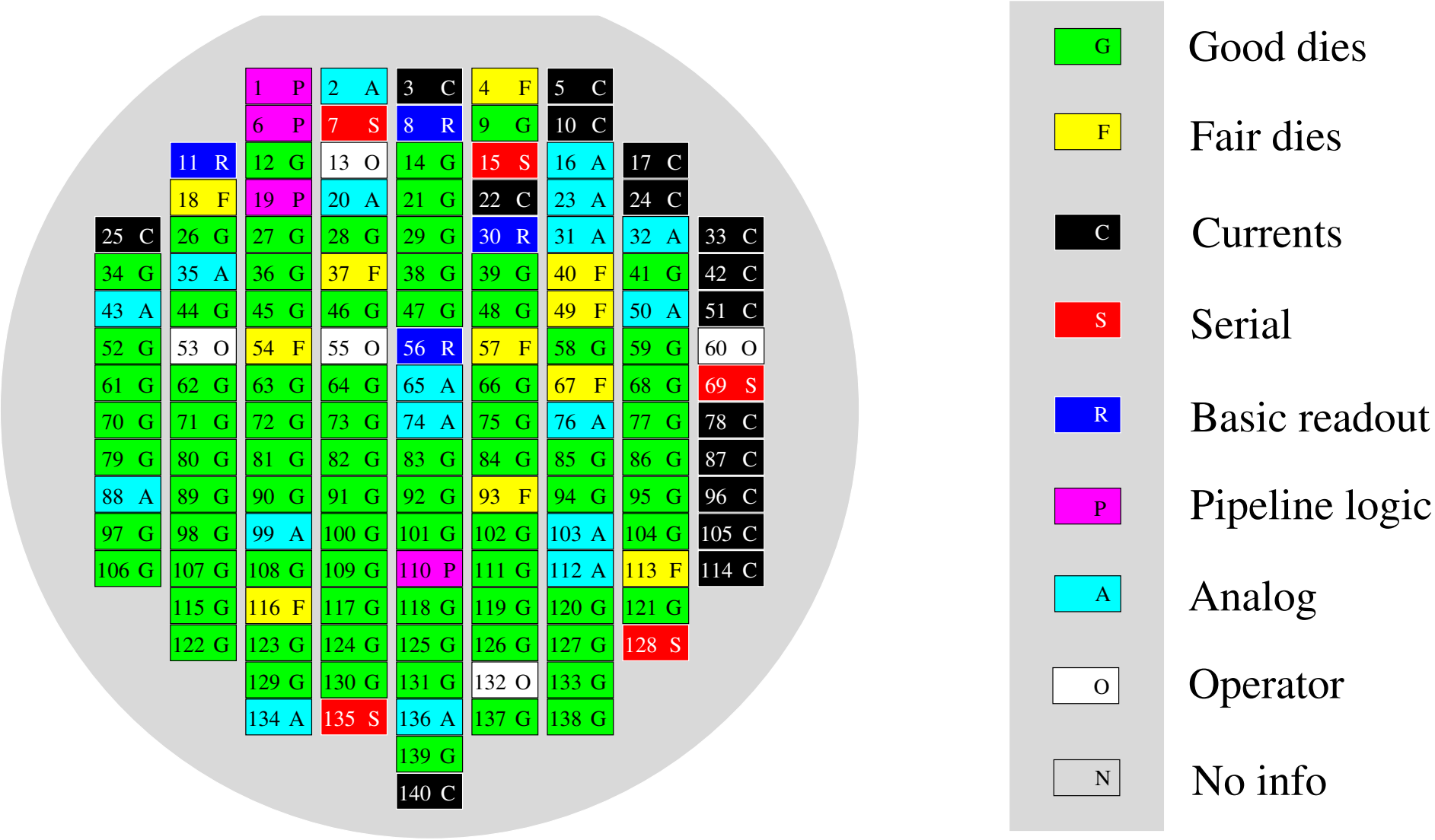
Types of die failures for wafer 87 s/n: Y21316-08-01

Date: 06/16/99